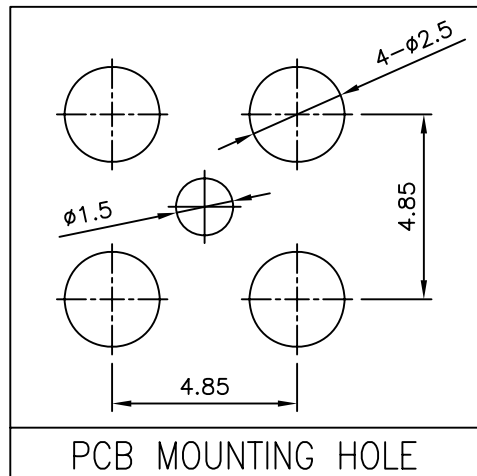
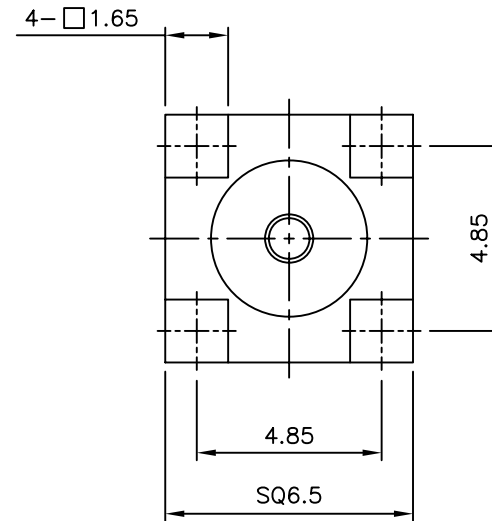
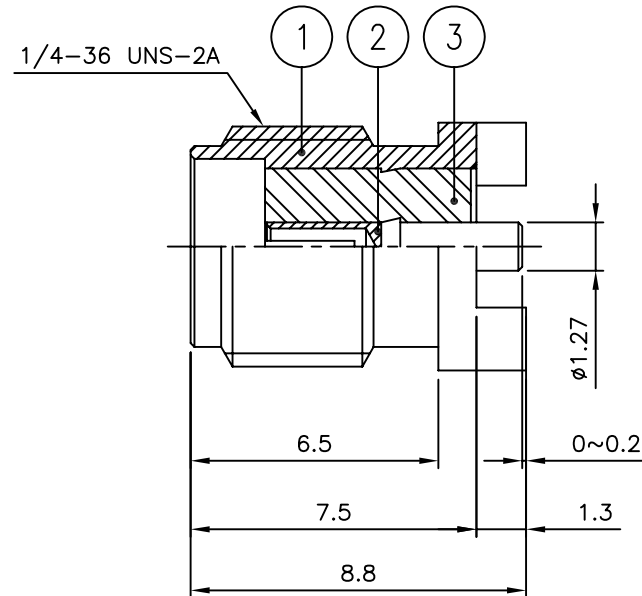


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2016.01.18.



* SMA PIN 높이 지그 사용하여 PIN 조립 할 것

3	INSULATOR	1	TEFLON		DIN01973-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03629-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04107-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2016. 01. 18.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SMA50 PCB JS-4R
		DRAWN BY	H.J.LEE	
FINISH		SCALE	5/1	A4 DWG NO. CN03546-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	